

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE40H21C uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

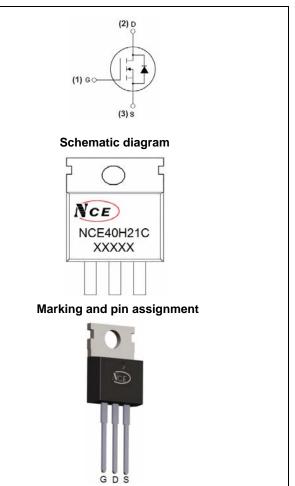
- V_{DS} =40V ,I_D =210A
 - $R_{DS(ON)} < 2.5 m\Omega @ V_{GS} = 10V$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



TO-220-3L top view

Package Marking and Ordering Information

ſ	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
	NCE40H21C	NCE40H21C	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	40	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	210	А	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	148	A	
Pulsed Drain Current	I _{DM}	840	A	
Maximum Power Dissipation	PD	310	W	
Derating factor		2.07	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	1800	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C	
Thermal Characteristic		·		
Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	0.48	°C/W	



Electrical Characteristics (T_A=25 $^\circ\! \mathbb{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	1.8	2.5	mΩ
Forward Transconductance	g fs	V _{DS} =10V,I _D =40A	160	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	7952	-	PF
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	1865	-	PF
Reverse Transfer Capacitance	C _{rss}		-	936	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	25	-	nS
Turn-on Rise Time	tr	V_{DD} =30V,RL=0.75 Ω ,	-	75	-	nS
Turn-Off Delay Time	t _{d(off)}	R _G =2.5Ω,V _{GS} =10V	-	80	-	nS
Turn-Off Fall Time	t _f		-	60	-	nS
Total Gate Charge	Qg		-	141.3	-	nC
Gate-Source Charge	Q _{gs}	I _D =40A,V _{DD} =20V,V _{GS} =10V	-	37.1	-	nC
Gate-Drain Charge	Q _{gd}		-	61.4	-	nC
Drain-Source Diode Characteristics	•					L
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-	0.85	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	210	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	47		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	76		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

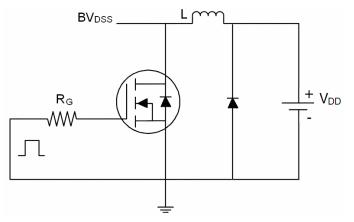
5. EAS condition: Tj=25 $^\circ \!\! ^\circ \!$



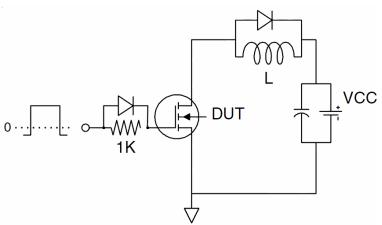
http://www.ncepower.com

Test circuit

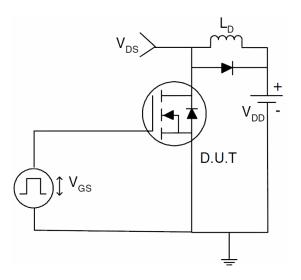
1) E_{AS} test Circuits



2) Gate charge test Circuit:

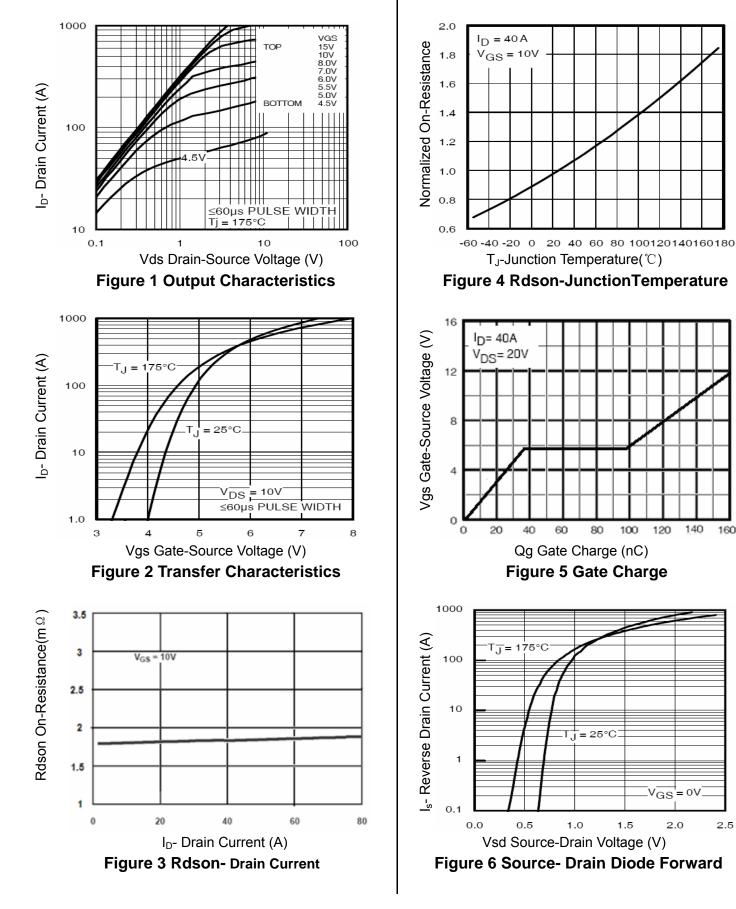


3) Switch Time Test Circuit:





Typical Electrical and Thermal Characteristics (Curves)



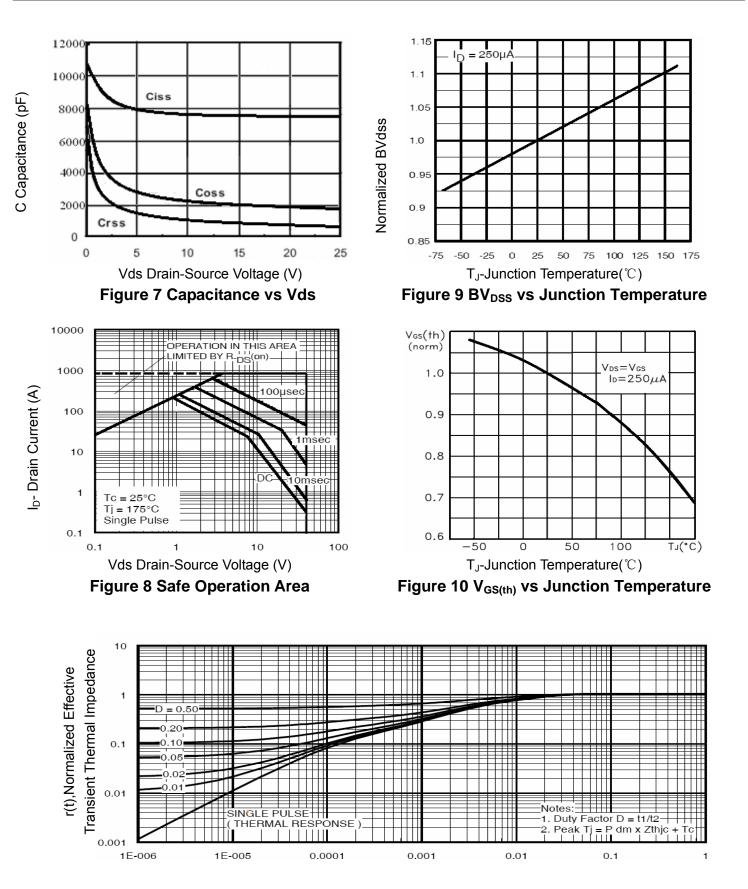
2.0

2.5

140

160

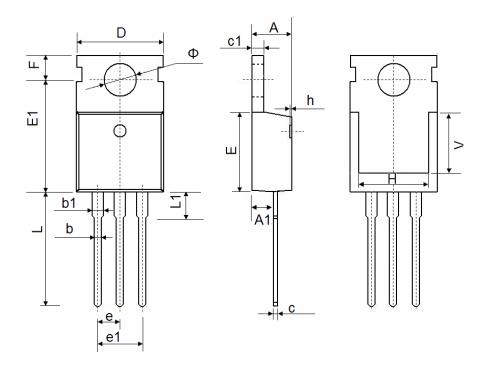




Square Wave Pluse Duration (sec) Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	2.540 TYP.		TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	7.500 REF.		REF.	
Ф	3.400	3.800	0.134	0.150	



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